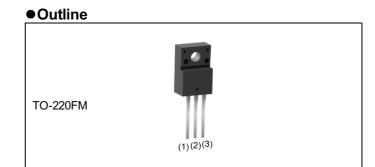
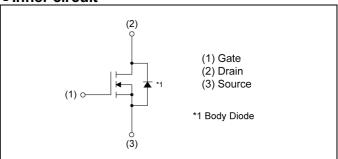


R6030KNX

V _{DSS}	600V
R _{DS(on)} (Max.)	0.130Ω
Ι _D	±30A
P _D	86W



●Inner circuit



Packaging specifications

, , ,	
Packing	Bulk
Reel size (mm)	-
Tape width (mm)	-
Basic ordering unit (pcs)	500
Taping code	-
Marking	R6030KNX
	Reel size (mm) Tape width (mm) Basic ordering unit (pcs) Taping code

● Absolute maximum ratings (T_a = 25°C, unless otherwise specified)

Parameter		Symbol	Value	Unit
Drain - Source voltage		V _{DSS}	600	V
Continuous drain current $(T_c = 2)$	۱ _D *1	±30	А	
Pulsed drain current	I _{DP} *2	±80	А	
Cata Cauraa valtaara	static	N/	±20	V
Gate - Source voltage	AC(f>1Hz)	V_{GSS}	±30	V
Avalanche current, single pulse	·	I _{AS}	5.2	А
Avalanche energy, single pulse		E _{AS} *3	636	mJ
Power dissipation ($T_c = 25^{\circ}C$)	P _D	86	W	
Junction temperature	Tj	150	°C	
Operating junction and storage to	T _{stg}	-55 to +150	°C	

Features1) Low on-resistance.2) Ultra fast switching speed.

3) Parallel use is easy.

Application

Switching

4) Pb-free lead plating ; RoHS compliant

Thermal resistance

Deremeter	Cumph of	Values			Linit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*4}	-	-	1.5	°C/W
Thermal resistance, junction - ambient	R _{thJA}	-	-	70	°C/W
Soldering temperature, wavesoldering for 10s	T _{sold}	-	-	265	°C

•Electrical characteristics (T_a = 25°C)

Parameter	Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	$V_{(BR)DSS}$ $V_{GS} = 0V, I_D = 1mA$		600	-	-	V
		V _{DS} = 600V, V _{GS} = 0V				
Zero gate voltage drain current	I _{DSS}	$T_j = 25^{\circ}C$	-	-	100	μA
		T _j = 125°C	-	-	1000	
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±100	nA
Gate threshold voltage	$V_{GS(th)}$	V _{DS} = 10V, I _D = 1mA	3	-	5	V
		V _{GS} = 10V, I _D = 14.5A				
Static drain - source on - state resistance	$R_{DS(on)}^{*5}$	$T_j = 25^{\circ}C$	-	0.115	0.130	Ω
		$T_j = 125^{\circ}C$	-	0.26	-	
Gate resistance	R _G	f = 1MHz, open drain	-	2.1	-	Ω



•Electrical characteristics (T_a = 25°C)

Deremeter	C: make al	Conditions		Linit			
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Forward Transfer Admittance	Y _{fs} ^{*5} V _{DS} = 10V, I _D = 15A		10	20	-	S	
Input capacitance	C _{iss}	ss V _{GS} = 0V		2350	-		
Output capacitance	C _{oss}	V _{DS} = 25V	-	2000	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	70	-		
Turn - on delay time	t _{d(on)} *5	$V_{DD} \simeq 300$ V, V_{GS} = 10V	-	35	-		
Rise time	t _r *5	I _D = 15A	-	65	-		
Turn - off delay time $t_{d(off)}^{*5}$		$R_L \simeq 20\Omega$	-	100	-	ns	
Fall time	t _f *5	R _G = 10Ω	-	50	-		

• Gate charge characteristics (T_a = 25°C)

Deremeter	Sumbol	Conditions	Values			Lincit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*5}	V _{DD} ≃ 300V	-	56	-	
Gate - Source charge	Q _{gs} *5	I _D = 30A	-	18	-	nC
Gate - Drain charge	Q _{gd} *5	V _{GS} = 10V	-	23	-	
Gate plateau voltage	V _(plateau)	$V_{DD} \simeq 300$ V, I _D = 30A	-	6.6	-	V

*1 Limited only by maximum channel temperature allowed.

*2 Pw \leq 10µs, Duty cycle \leq 1%

*3 L \doteqdot 50mH, V_{DD}=50V, R_G=25 Ω , STARTING T_j=25°C

*4 T_C=25°C

*5 Pulsed

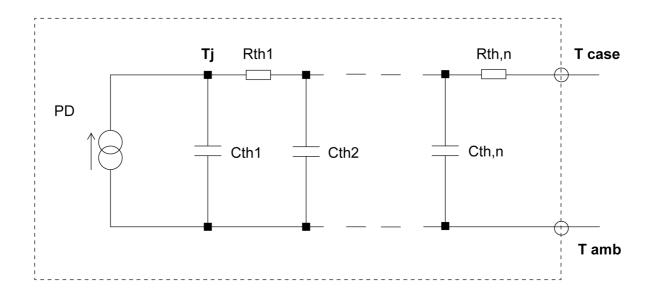


•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Sumbol	Conditions		Unit			
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Continuous forward current	۱ _S *1	T - 25°0	-	-	30	А	
Pulse forward current	ا _{SP} *2	T _C = 25°C	-	-	80	А	
Forward voltage	V_{SD}^{*5}	V _{GS} = 0V, I _S = 30A	-	-	1.5	V	
Reverse recovery time	t _{rr} *5		-	517	-	ns	
Reverse recovery charge	Q _{rr} *5	I _S = 30A di/dt = 100A/µs	-	9.6	-	μC	
Peak reverse recovery current	۲ _{rrm} *5		-	37	-	А	

• Typical transient thermal characteristics

Symbol	Value	Unit	Symbol	Value	Unit
R _{th1}	0.0973		 C _{th1}	0.00375	
R _{th2}	0.618	K/W	 C _{th2}	0.0519	Ws/K
R _{th3}	2.14		 C _{th3}	0.524	





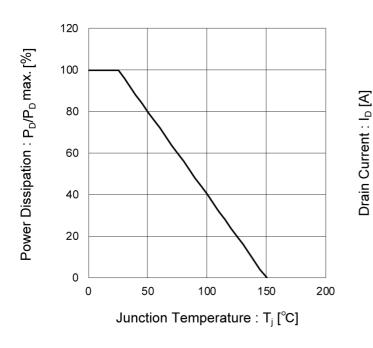


Fig.1 Power Dissipation Derating Curve

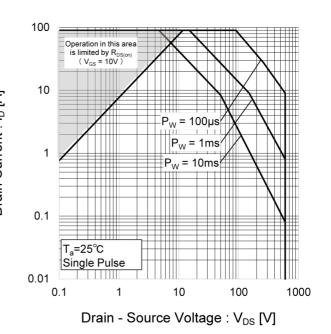
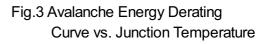
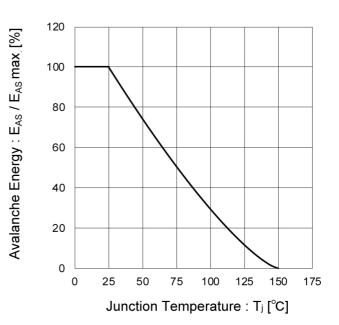


Fig.2 Maximum Safe Operating Area





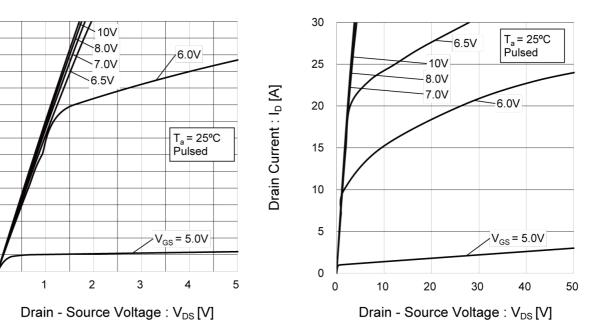


• Electrical characteristic curves



Fig.4 Typical Output Characteristics(I)

Fig.5 Typical Output Characteristics(II)





• Electrical characteristic curves

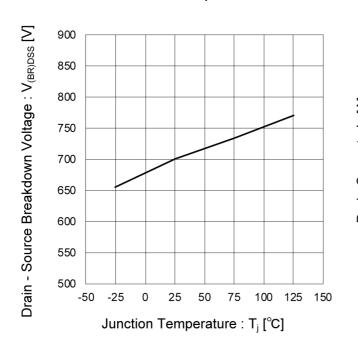


Fig.6 Breakdown Voltage vs. Junction Temperature

Fig.7 Typical Transfer Characteristics

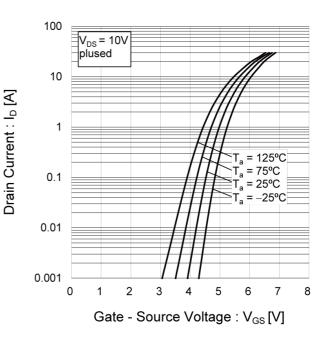


Fig.8 Gate Threshold Voltage vs. Junction Temperature



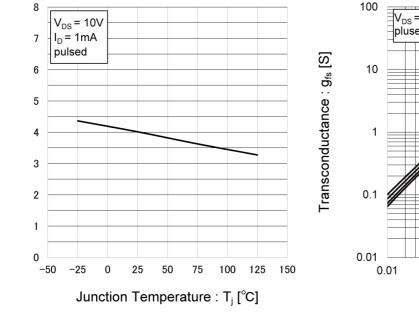
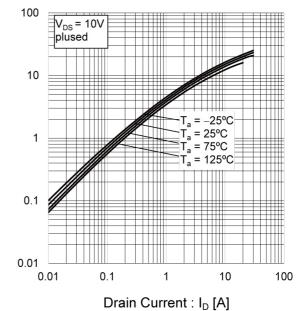


Fig.9 Forward Transfer Admittance vs. Drain Current





• Electrical characteristic curves

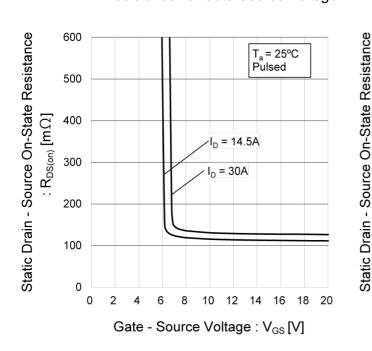
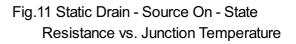


Fig.10 Static Drain - Source On - State Resistance vs. Gate Source Voltage



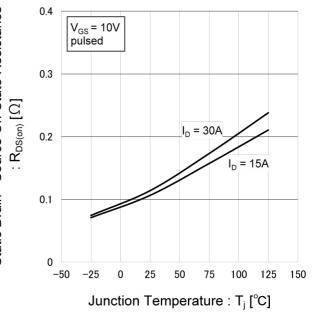
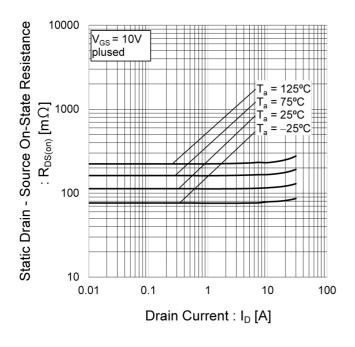


Fig.12 Static Drain - Source On - State Resistance vs. Drain Current(I)





• Electrical characteristic curves

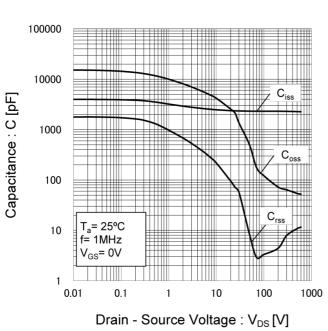
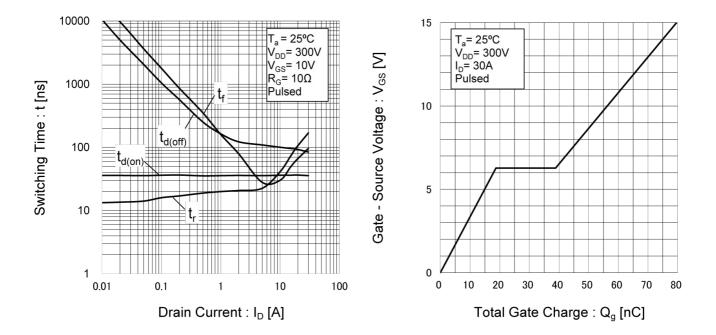


Fig.13 Typical Capacitance vs. Drain - Source Voltage

Fig.14 Switching Characteristics

Fig.15 Dynamic Input Characteristics



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Fig.17 Reverse Recovery Time vs.

Inverse Diode Forward Current

• Electrical characteristic curves

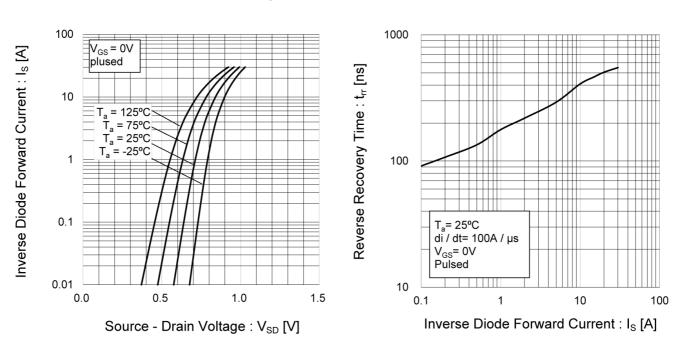


Fig.16 Inverse Diode Forward Current vs. Source - Drain Voltage



Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

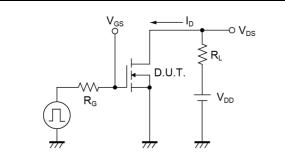


Fig.2-1 Gate Charge Measurement Circuit

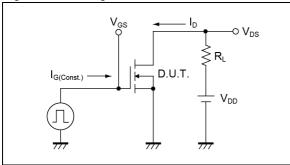


Fig.3-1 Avalanche Measurement Circuit

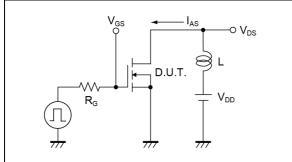


Fig.4-1 dv/dt Measurement Circuit

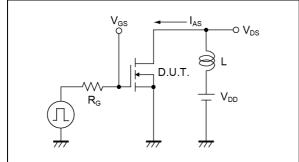


Fig.5-1 dv/dt Measurement Circuit

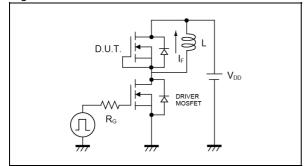


Fig.1-2 Switching Waveforms

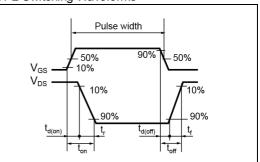


Fig.2-2 Gate Charge Waveform

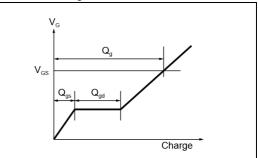


Fig.3-2 Avalanche Waveform

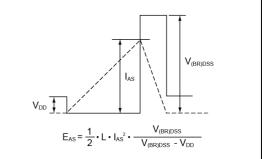


Fig.4-2 dv/dt Waveform

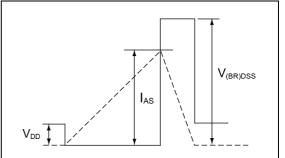
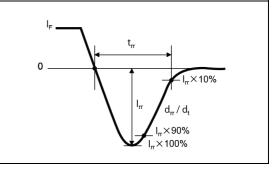
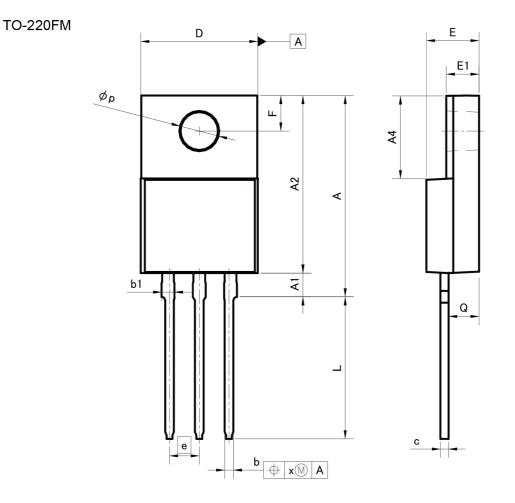


Fig.5-2 dv/dt Waveform





Dimensions



	MILIM	ETERS	INC	HES
			MIN	MAX
A	16.60	17.60	0.654	0.693
A1	1.80	2.20	0.071	0.087
A2	14.80	15.40	0.583	0.606
A4	6.80	7.20	0.268	0.283
b	0.70	0.85	0.028	0.033
b1	1.10	1.50	0.043	0.059
с	0.70	0.85	0.028	0.033
D	9.90	10.30	0.390	0.406
E	4.40	4.80	0.173	0.189
е	2.	54	0.1	00
E1	2.70	3.00	0.106	0.118
F	2.80	3.20	0.110	0.126
L	11.50	12.50	0.453	0.492
р	3.00	3.40	0.118	0.134
Q	2.10	3.10	0.083	0.122
x	n	0.38	_	0.015

Dimension in mm/inches



Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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CLASSⅣ	CLASSII	CLASSⅢ	CLASSII

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 - [a] Installation of protection circuits or other protective devices to improve system safety
 - [b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure
- 3. Our Products are designed and manufactured for use under standard conditions and not under any special or extraordinary environments or conditions, as exemplified below. Accordingly, ROHM shall not be in any way responsible or liable for any damages, expenses or losses arising from the use of any ROHM's Products under any special or extraordinary environments or conditions. If you intend to use our Products under any special or extraordinary environments or conditions (as exemplified below), your independent verification and confirmation of product performance, reliability, etc, prior to use, must be necessary:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [C] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

Precaution for Product Label

QR code printed on ROHM Products label is for ROHM's internal use only.

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When disposing Products please dispose them properly using an authorized industry waste company.

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R6030KNX - Web Page

Distribution Inventory

Part Number	R6030KNX
Package	TO-220FM
Unit Quantity	1000
Minimum Package Quantity	1000
Packing Type	Bulk
Constitution Materials List	inquiry
RoHS	Yes